



JCS24N50H

主要参数 MAIN CHARACTERISTICS

ID	24 A
VDSS	500 V
Rdson-max (@Vgs=10V))	0.19 Ω
Qg-typ	81nC

用途

- 高频开关电源
- 电子镇流器
- UPS 电源

产品特性

- 低栅极电荷
- 低 C_{RSS} (典型值 34pF)
- 开关速度快
- 产品全部经过雪崩测试
- 高抗 dv/dt 能力
- RoHS 产品

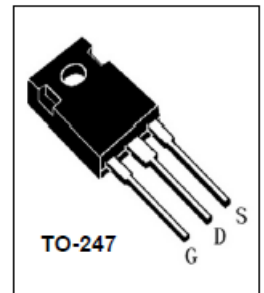
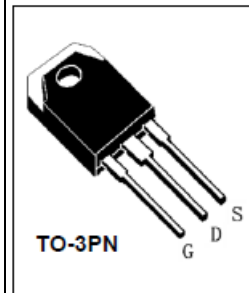
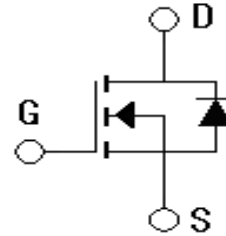
APPLICATIONS

- High efficiency switch mode power supplies
- Electronic lamp ballasts based on half bridge
- UPS

FEATURES

- Low gate charge
- Low C_{RSS} (typical 34pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- RoHS product

封装 Package



订货信息 ORDER MESSAGE

订货型号 Order codes	印记 Marking	封装 Package	无卤素 Halogen Free	包装 Packaging	器件重量 Device Weight
JCS24N50ANH-O-AN-N-B	JCS24N50ANH	TO-3PN	否 NO	条管 Tube	5.73g(typ)
JCS24N50WH-O-W-N-B	JCS24N50WH	TO-247	否 NO	条管 Tube	5.20g(typ)



绝对最大额定值 ABSOLUTE RATINGS ($T_c=25^{\circ}\text{C}$)

项 目 Parameter	符 号 Symbol	数 值 Value	单 位 Unit
		JCS24N50ANH/WH	
最高漏极—源极直流电压 Drain-Source Voltage	V_{DSS}	500	V
连续漏极电流 Drain Current -continuous	I_{D} $T=25^{\circ}\text{C}$ $T=100^{\circ}\text{C}$	24.0*	A
		14.0*	A
最大脉冲漏极电流 (注 1) Drain Current -pulse (note 1)	I_{DM}	96*	A
最高栅源电压 Gate-Source Voltage	V_{GSS}	± 30	V
单脉冲雪崩能量 (注 2) Single Pulsed Avalanche Energy (note 2)	E_{AS}	1760	mJ
雪崩电流 (注 1) Avalanche Current (note 1)	I_{AR}	24.0	A
重复雪崩能量 (注 1) Repetitive Avalanche Current (note 1)	E_{AR}	2.8	mJ
二极管反向恢复最大电压变化速率 (注 3) Peak Diode Recovery dv/dt (note 3)	dv/dt	4.5	V/ns
耗散功率 Power Dissipation	P_{D} $T_c=25^{\circ}\text{C}$ -Derate above 25°C	271	W
		2.22	W/ $^{\circ}\text{C}$
最高结温及存储温度 Operating and Storage Temperature Range	$T_{\text{J}}, T_{\text{STG}}$	$-55 \sim +150$	$^{\circ}\text{C}$
引线最高焊接温度 Maximum Lead Temperature for Soldering Purposes	T_{L}	300	$^{\circ}\text{C}$

*漏极电流由最高结温限制

*Drain current limited by maximum junction temperature





电特性 ELECTRICAL CHARACTERISTIC

项 目 Parameter	符 号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单 位 Units
关态特性 Off –Characteristics						
漏—源击穿电压 Drain-Source Voltage	BV_{DSS}	$I_D=250\mu A, V_{GS}=0V$	500	-	-	V
击穿电压温度特性 Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS} / \Delta T_J$	$I_D=250\mu A$, referenced to $25^\circ C$	-	0.5	-	V/ $^\circ C$
零栅压下漏极漏电流 Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=500V, V_{GS}=0V, T_C=25^\circ C$	-	-	10	μA
		$V_{DS}=400V, T_C=125^\circ C$	-	-	100	μA
正向栅极体漏电流 Gate-body leakage current, forward	I_{GSSF}	$V_{DS}=0V, V_{GS}=30V$	-	-	100	nA
反向栅极体漏电流 Gate-body leakage current, reverse	I_{GSSR}	$V_{DS}=0V, V_{GS}=-30V$	-	-	-100	nA
通态特性 On-Characteristics						
阈值电压 Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D=250\mu A$	3.0	-	5.0	V
静态导通电阻 Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=12A$	-	0.16	0.19	Ω
正向跨导 Forward Transconductance	g_{fs}	$V_{DS}=40V, I_D=12A$ (note 4)	-	27.5	-	S
动态特性 Dynamic Characteristics						
输入电容 Input capacitance	C_{iss}	$V_{DS}=25V,$ $V_{GS}=0V,$ $f=1.0MHz$	-	3100	4160	pF
输出电容 Output capacitance	C_{oss}		-	465	620	pF
反向传输电容 Reverse transfer capacitance	C_{rss}		-	34	55	pF





电特性 ELECTRICAL CHARACTERISTICS

项 目 Parameter	符 号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units
开关特性 Switching –Characteristics						
延迟时间 Turn-On delay time	t _d (on)	V _{DD} =250V,I _D =24A,R _G =25Ω (note 4, 5)	-	48	105	ns
上升时间 Turn-On rise time	t _r		-	107	225	ns
延迟时间 Turn-Off delay time	t _d (off)		-	165	340	ns
下降时间 Turn-Off Fall time	t _f		-	85	180	ns
栅极电荷总量 Total Gate Charge	Q _g	V _{DS} =400V ,	-	81	100	nC
栅—源电荷 Gate-Source charge	Q _{gs}	I _D =24A	-	20	-	nC
栅—漏电荷 Gate-Drain charge	Q _{gd}	V _{GS} =10V (note 4, 5)	-	30	-	nC
漏—源二极管特性及最大额定值 Drain-Source Diode Characteristics and Maximum Ratings						
正向最大连续电流 Maximum Continuous Drain-Source Diode Forward Current	I _S		-	-	24	A
正向最大脉冲电流 Maximum Pulsed Drain-Source Diode Forward Current	I _{SM}		-	-	96	A
正向最大连续电流 Maximum Continuous Drain-Source Diode Forward Current	V _{SD}	V _{GS} =0V, I _S =24A	-		1.4	V
反向恢复时间 Reverse recovery time	t _{rr}	V _{GS} =0V, I _S =24A dI _F /dt=100A/μs (note 4)		530		ns
反向恢复电荷 Reverse recovery charge	Q _{rr}			8.2		μC

热特性 THERMAL CHARACTERISTIC

项 目 Parameter	符 号 Symbol	最大值 Value	单 位 Unit
		JCS24N50ANH/WH	
结到管壳的热阻 Thermal Resistance, Junction to Case	$R_{th(j-c)}$	0.45	$^{\circ}C/W$
结到环境的热阻 Thermal Resistance, Junction to Ambient	$R_{th(j-A)}$	40.0	$^{\circ}C/W$

注:

- 1: 脉冲宽度由最高结温限制
- 2: $L=5.5mH, I_{AS}=24A, V_{DD}=50V, R_G=25\Omega$, 起始结温 $T_J=25^{\circ}C$
- 3: $I_{SD} \leq 24A, di/dt \leq 200A/\mu s, V_{DD} \leq BV_{DSS}$, 起始结温 $T_J=25^{\circ}C$
- 4: 脉冲测试: 脉冲宽度 $\leq 300\mu s$, 占空比 $\leq 2\%$
- 5: 基本与工作温度无关

Notes:

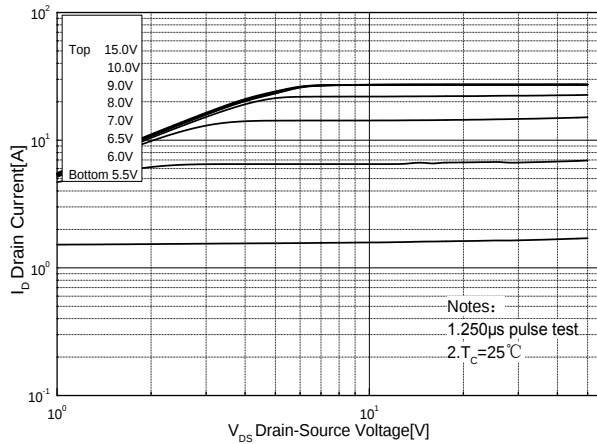
- 1: Pulse width limited by maximum junction temperature
- 2: $L=5.5mH, I_{AS}=24A, V_{DD}=50V, R_G=25\Omega$, Starting $T_J=25^{\circ}C$
- 3: $I_{SD} \leq 24A, di/dt \leq 200A/\mu s, V_{DD} \leq BV_{DSS}$, Starting $T_J=25^{\circ}C$
- 4: Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$
- 5: Essentially independent of operating temperature



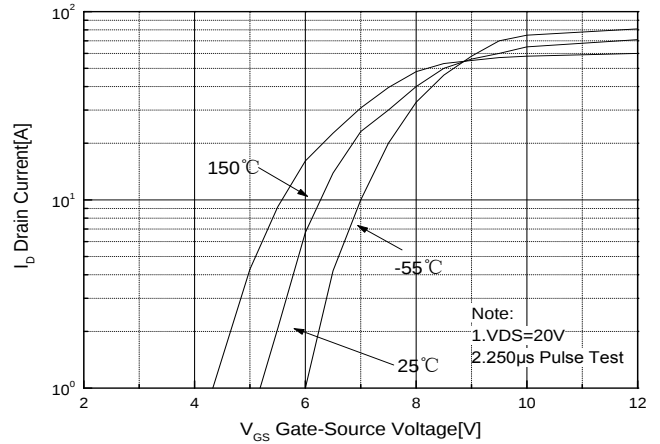


特征曲线 ELECTRICAL CHARACTERISTICS (curves)

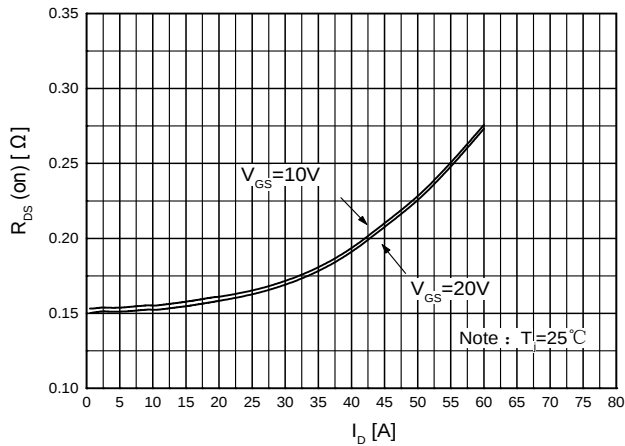
On-Region Characteristics



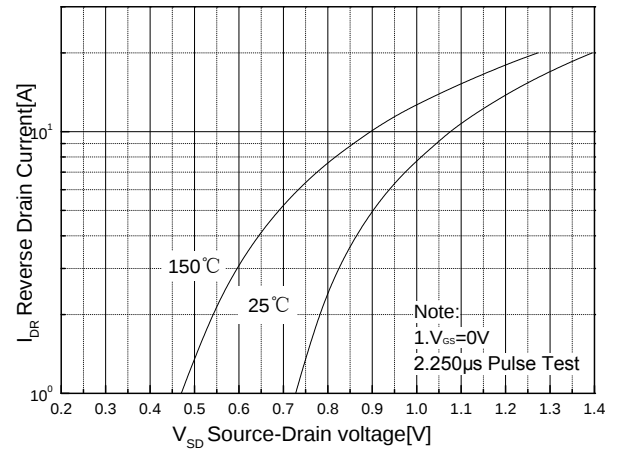
Transfer Characteristics



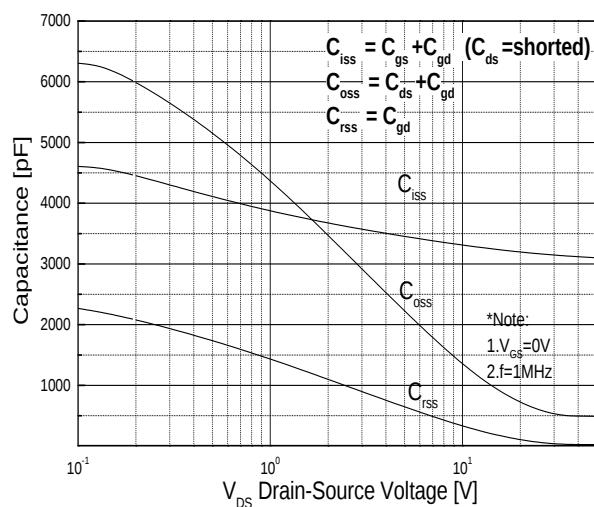
On-Resistance Variation vs Drain Current and Gate Voltage



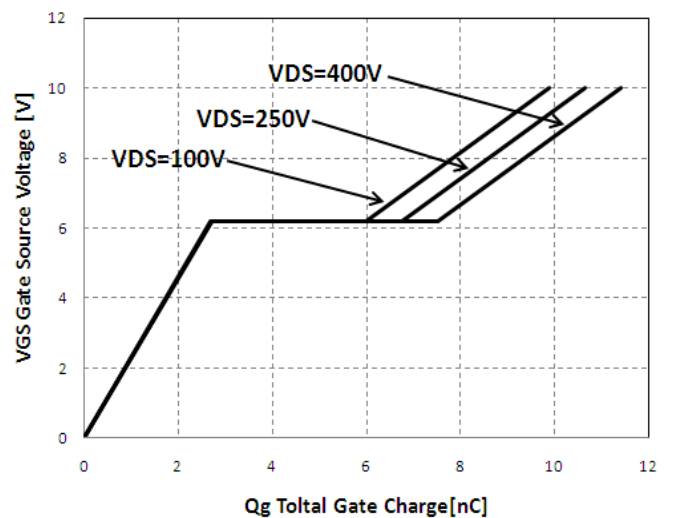
Body Diode Forward Voltage Variation vs. Source Current and Temperature



Capacitance Characteristics

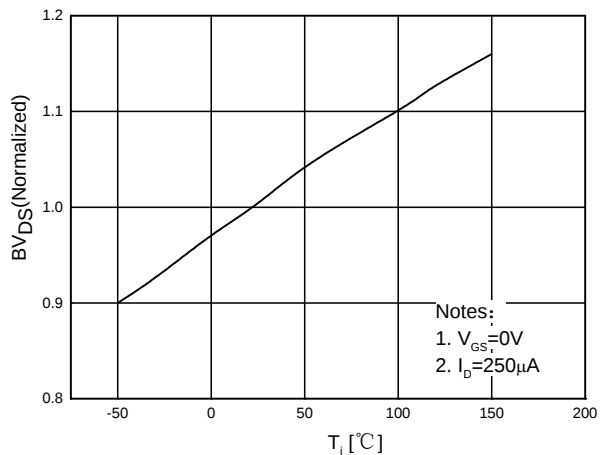
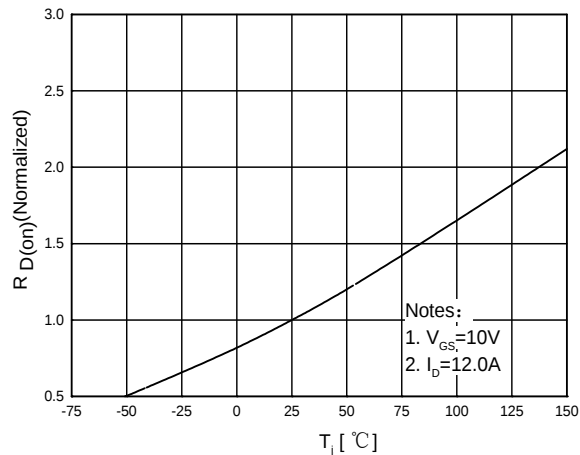


Capacitance Characteristics

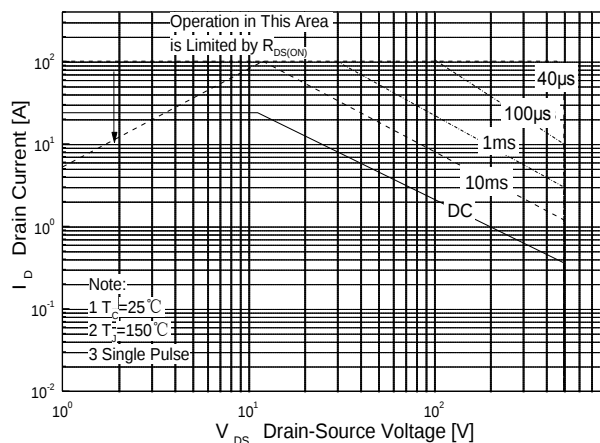




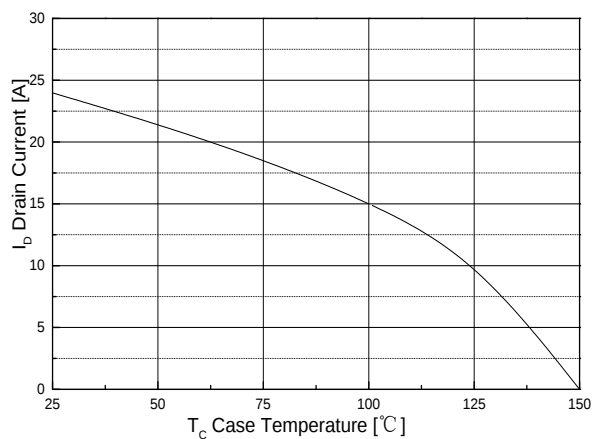
特征曲线 ELECTRICAL CHARACTERISTICS (curves)

Breakdown Voltage Variation
vs. TemperatureOn-Resistance Variation
vs. Temperature

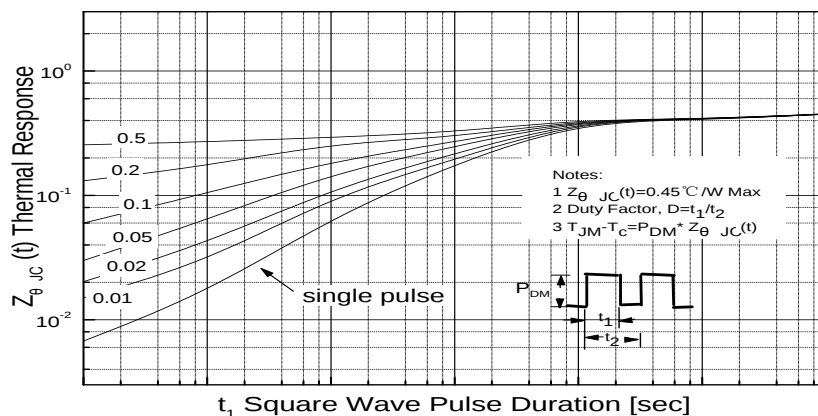
Maximum Safe Operating Area



Maximum Drain Current vs. Case Temperature



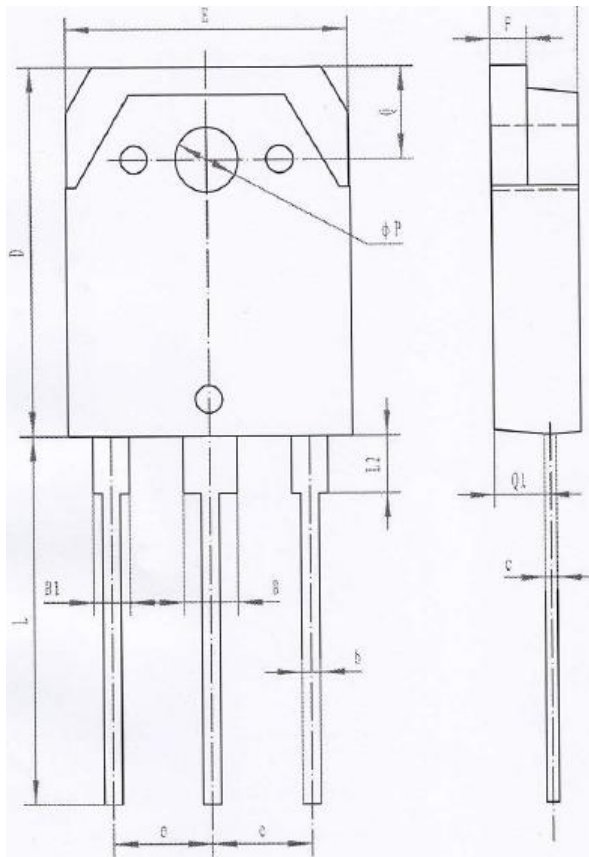
Transient Thermal Response Curve





TO-3PN

单位 Unit : mm



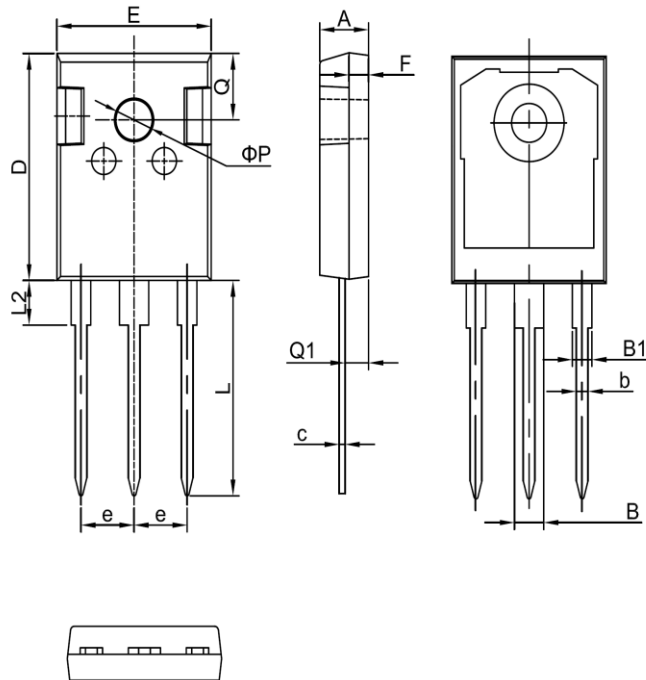
符号 symbol	MIN	MAX
A	4.55	4.95
B	2.90	3.20
B1	1.90	2.20
b	0.90	1.10
c	0.40	0.80
D	19.70	20.10
E	15.30	15.70
e	5.45(TYP)	
F	1.90	2.10
L	19.50	20.50
L2	3.05	3.25
Q	4.90	5.10
Q1	2.60	3.00
P	3.30	3.70





TO-247

单位 Unit : mm



符号 symbol	MIN	MAX
A	4.90	5.10
B	2.95	3.35
B1	1.95	2.35
b	1.15	1.35
c	0.50	0.70
D	20.90	21.10
E	15.70	15.90
e	5.34	5.54
F	1.90	2.10
L	19.40	20.40
L2	4.03	4.23
Q	6.00	6.40
Q1	2.30	2.50
P	3.50	3.70





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4. 本说明书如有版本变更不另外告知

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